

# 2A, 100V - 200V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency switching
- DC/DC
- Snubber

### **MECHANICAL DATA**

• Case: SOD-123W

• Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Meet JESD 201 class 2 whisker test

• Polarity: Indicated by cathode band

• Weight: 0.015g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	2	Α	
$V_{RRM}$	100 - 200	V	
I <sub>FSM</sub>	50	Α	
$T_{JMAX}$	175	°C	
Package	SOD-123W		
Configuration	Single die		









**SOD-123W** 



PARAMETER		SYMBOL	PU2BLWH	PU2DLWH	UNIT
Marking code on the device			U2BLW	U2DLW	
Repetitive peak reverse voltage		$V_{RRM}$	100	200	V
Reverse voltage, total rms value		V <sub>R(RMS)</sub>	70	140	V
Forward current		I <sub>F</sub>	2		А
Surge peak forward current single half	t = 8.3ms		50 140		А
sine-wave superimposed on rated load	t = 1.0ms	- I <sub>FSM</sub>			
Junction temperature		TJ	-55 to +175		°C
Storage temperature		T <sub>STG</sub>	-55 to +175		°C

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THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	R <sub>OJL</sub>	17	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	75	°C/W
Junction-to-case thermal resistance	R <sub>eJC</sub>	22	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C		0.81	-	V
	I <sub>F</sub> = 2A, T <sub>J</sub> = 25°C		0.87	0.93	V
	I <sub>F</sub> = 1A, T <sub>J</sub> = 125°C	$V_{F}$	0.66	-	V
	I <sub>F</sub> = 2A, T <sub>J</sub> = 125°C		0.73	-	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	T <sub>J</sub> = 25°C		-	2	μA
	T <sub>J</sub> = 125°C	l <sub>R</sub>	-	10	μΑ
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	33	-	pF
Deveree receiver time	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$	4	-	25	ns
Reverse recovery time	$I_F = 1.0A$ , di/dt = 50A/ $\mu$ s, $V_R = 30V$	t <sub>rr</sub>	30	-	
Reverse recovery current		I <sub>RM</sub>	3.6	-	Α
Reverse recovery charge	$I_F = 2.0A$ , di/dt = 200A/ $\mu$ s, $V_R = 100V$	Q <sub>rr</sub>	31	-	nC
Reverse recovery time		t <sub>rr</sub>	19	-	ns

### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING
PU2xLWH	SOD-123W	10,000/ Tape & Reel

### Notes:

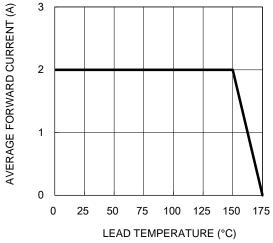
1. "x" defines voltage from 100V(PU2BLWH) to 200V(PU2DLWH)

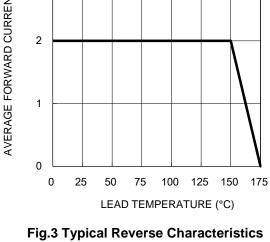


### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve







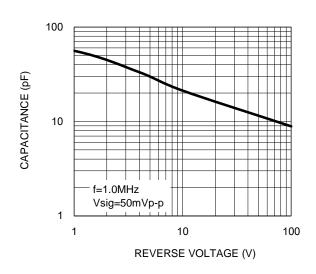
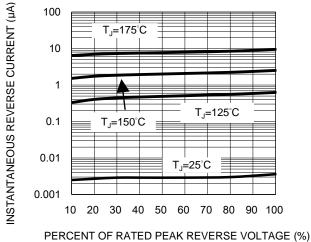


Fig.4 Typical Forward Characteristics





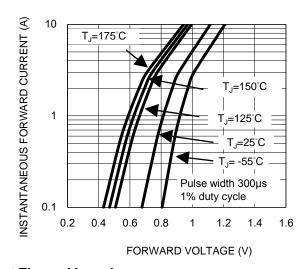
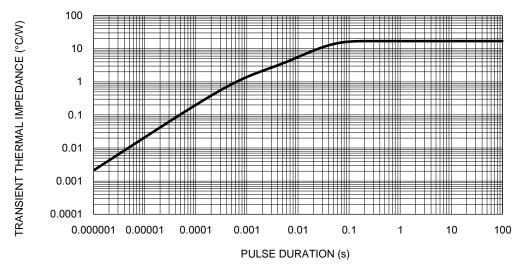


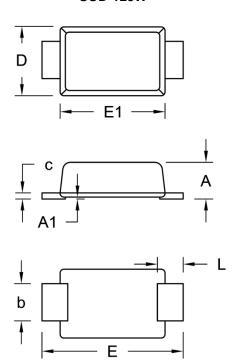
Fig.5 Typical Transient Thermal Impedance





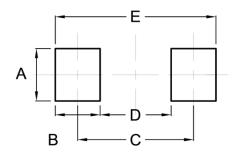
# **PACKAGE OUTLINE DIMENSIONS**

**SOD-123W** 



DIM.	Unit (mm)		Unit (	inch)	
DIIVI.	Min.	Max.	Min.	Max.	
Α	0.90	1.02	0.035	0.040	
A1	0.00	0.10	0.000	0.004	
b	0.90	1.05	0.035	0.041	
С	0.10	0.22	0.004	0.009	
D	1.70	1.90	0.067	0.075	
E	3.60	3.80	0.142	0.150	
E1	2.60	2.90	0.102	0.114	
L	0.50	0.85	0.020	0.033	

# **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	1.40	0.055
В	1.20	0.047
С	3.10	0.122
D	1.90	0.075
E	4.30	0.169

# **MARKING DIAGRAM**



P/N = Marking Code YW = Date Code F = Factory Code



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